

09030-030701

As a below named inventor, I hereby declare that:

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled
**INTEGRATED CIRCUIT DEVICES HAVING DIELECTRIC REGIONS
PROTECTED WITH MULTI-LAYER INSULATION STRUCTURES AND
METHODS OF FABRICATING SAME.**

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37 Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent or inventor's certificate, or of any PCT International application having a filing date before that of the application on which priority is claimed.

2000-46615	Korea	08/11/2000	[X] Yes [] No
Number	Country	MM/DD/YYYY Filed	Priority Claimed
			[] Yes [] No
Number	Country	MM/DD/YYYY Filed	Priority Claimed
			[] Yes [] No
Number	Country	MM/DD/YYYY Filed	Priority Claimed

ENGLISH LANGUAGE DECLARATION CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following registered attorney(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

Customer Number 20792

I hereby authorize the above-named attorneys to accept and follow instructions from my Korean or United States representatives, Samsung Electronics, as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the above-named attorneys and myself. In the event of a change in the persons from whom instructions may be taken, I will notify the above-named attorneys.

Send correspondence to: Grant J. Scott
Myers Bigel Sibley & Sajovec, P.A.
Post Office Box 37428
Raleigh, NC 27627

Direct telephone calls to: Grant J. Scott
(919) 854-1400

Facsimile: (919) 854-1401

Full name of first joint inventor: Hag-ju Cho

Inventor's
Signature: Hag-Ju Cho Date: 23rd July, 2001

Residence: Seoul, Republic of Korea

Citizenship: Republic of Korea

Post Office Address: 103-150, Boramae Samsung Apt.
Pongcheon 1-dong, Kwanank-gu
Seoul, Republic of Korea

Full name of second joint inventor: Hyeong-geun An

ENGLISH LANGUAGE DECLARATION CONTINUED

Inventor's
Signature: Hyeong-jeun Am Date: 12th July. 2001

Residence: Kyungki-do, Republic of Korea

Citizenship: Republic of Korea

Post Office Address: 201-1406, Dongshin Apt., Shingok 1-dong
Euijeongbu-city
Kyungki-do, Republic of Korea